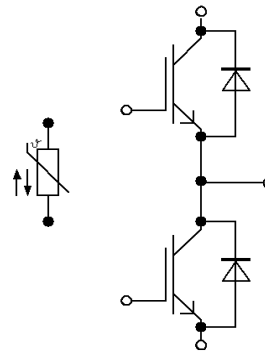
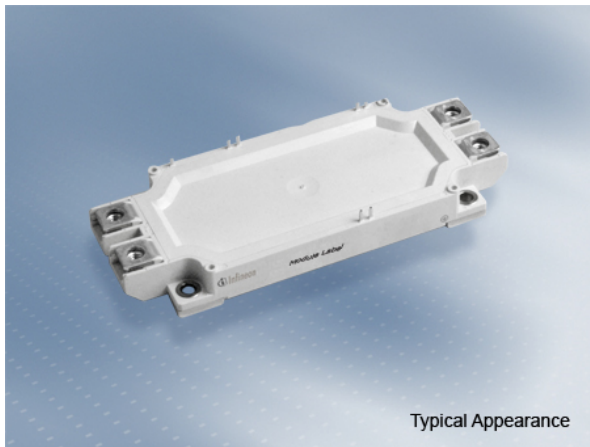


EconoDUAL™3 模块 采用第四代沟槽栅/场终止IGBT4和发射极控制二极管 带有温度检测NTC 和预涂导热介质  
 EconoDUAL™3 module with Trench/Fieldstop IGBT4 and Emitter Controlled diode and NTC / pre-applied Thermal Interface Material



$V_{CES} = 1200V$   
 $I_{C\ nom} = 600A / I_{CRM} = 1200A$

### 典型应用

- 大功率变流器
- 电机传动
- 伺服驱动器
- UPS系统
- 风力发电机

### 电气特性

- 低  $V_{CEsat}$
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CEsat}$  带正温度系数

### 机械特性

- 高功率密度
- 绝缘的基板
- 标准封装
- 预涂导热介质

### Typical Applications

- High power converters
- Motor drives
- Servo drives
- UPS systems
- Wind turbines

### Electrical Features

- LOW  $V_{CEsat}$
- $T_{vj\ op} = 150^{\circ}C$
- $V_{CEsat}$  with positive temperature coefficient

### Mechanical Features

- High power density
- Isolated base plate
- Standard housing
- Pre-applied Thermal Interface Material

## Module Label Code

Barcode Code 128



DMX - Code



### Content of the Code

Content of the Code	Digit
Module Serial Number	1 - 5
Module Material Number	6 - 11
Production Order Number	12 - 19
Datecode (Production Year)	20 - 21
Datecode (Production Week)	22 - 23

## IGBT, 逆变器 / IGBT, Inverter

## 最大额定值 / Maximum Rated Values

集电极 - 发射极电压 Collector-emitter voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{CES}$	1200	V
连续集电极直流电流 Continuous DC collector current	$T_H = 75^{\circ}\text{C}, T_{vj\max} = 175^{\circ}\text{C}$	$I_{C\text{nom}}$	600	A
集电极重复峰值电流 Repetitive peak collector current	$t_P = 1\text{ ms}$	$I_{CRM}$	1200	A
栅极 - 发射极峰值电压 Gate-emitter peak voltage		$V_{GES}$	+/-20	V

## 特征值 / Characteristic Values

		min.	typ.	max.		
集电极 - 发射极饱和电压 Collector-emitter saturation voltage	$I_C = 600\text{ A}, V_{GE} = 15\text{ V}$		1,75	2,10	V	
	$I_C = 600\text{ A}, V_{GE} = 15\text{ V}$		2,00		V	
	$I_C = 600\text{ A}, V_{GE} = 15\text{ V}$		2,05		V	
栅极阈值电压 Gate threshold voltage	$I_C = 23,0\text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GEth}$	5,20	5,80	6,40	V
栅极电荷 Gate charge	$V_{GE} = -15\text{ V} \dots +15\text{ V}$	$Q_G$	4,40		$\mu\text{C}$	
内部栅极电阻 Internal gate resistor	$T_{vj} = 25^{\circ}\text{C}$	$R_{Gint}$	1,2		$\Omega$	
输入电容 Input capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$	$C_{ies}$	37,0		nF	
反向传输电容 Reverse transfer capacitance	$f = 1\text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25\text{ V}, V_{GE} = 0\text{ V}$	$C_{res}$	2,05		nF	
集电极-发射极截止电流 Collector-emitter cut-off current	$V_{CE} = 1200\text{ V}, V_{GE} = 0\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{CES}$		3,0	mA	
栅极-发射极漏电流 Gate-emitter leakage current	$V_{CE} = 0\text{ V}, V_{GE} = 20\text{ V}, T_{vj} = 25^{\circ}\text{C}$	$I_{GES}$		400	nA	
开通延迟时间(电感负载) Turn-on delay time, inductive load	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}$		0,16		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,21		$\mu\text{s}$	
	$R_{Gon} = 1,5\ \Omega$		0,21		$\mu\text{s}$	
上升时间(电感负载) Rise time, inductive load	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}$		0,09		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,09		$\mu\text{s}$	
	$R_{Gon} = 1,5\ \Omega$		0,10		$\mu\text{s}$	
关断延迟时间(电感负载) Turn-off delay time, inductive load	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}$		0,48		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,61		$\mu\text{s}$	
	$R_{Goff} = 1,5\ \Omega$		0,65		$\mu\text{s}$	
下降时间(电感负载) Fall time, inductive load	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}$		0,07		$\mu\text{s}$	
	$V_{GE} = \pm 15\text{ V}$		0,11		$\mu\text{s}$	
	$R_{Goff} = 1,5\ \Omega$		0,12		$\mu\text{s}$	
开通损耗能量(每脉冲) Turn-on energy loss per pulse	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}, L_S = 35\text{ nH}$		62,5		mJ	
	$V_{GE} = \pm 15\text{ V}, di/dt = 5100\text{ A}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$		83,0		mJ	
	$R_{Gon} = 1,5\ \Omega$		90,0		mJ	
关断损耗能量(每脉冲) Turn-off energy loss per pulse	$I_C = 600\text{ A}, V_{CE} = 600\text{ V}, L_S = 35\text{ nH}$		47,0		mJ	
	$V_{GE} = \pm 15\text{ V}, du/dt = 3700\text{ V}/\mu\text{s} (T_{vj} = 150^{\circ}\text{C})$		72,0		mJ	
	$R_{Goff} = 1,5\ \Omega$		79,5		mJ	
短路数据 SC data	$V_{GE} \leq 15\text{ V}, V_{CC} = 800\text{ V}$ $V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$ $t_P \leq 10\ \mu\text{s}, T_{vj} = 150^{\circ}\text{C}$	$I_{SC}$	2400		A	
结 - 散热器热阻 Thermal resistance, junction to heatsink	每个 IGBT / per IGBT valid with IFX pre-applied thermal interface material	$R_{thJH}$		0,0652	K/W	
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{op}}$	-40	150	$^{\circ}\text{C}$	

## 二极管, 逆变器 / Diode, Inverter 最大额定值 / Maximum Rated Values

反向重复峰值电压 Repetitive peak reverse voltage	$T_{vj} = 25^{\circ}\text{C}$	$V_{RRM}$	1200	V
连续正向直流电流 Continuous DC forward current		$I_F$	600	A
正向重复峰值电流 Repetitive peak forward current	$t_P = 1\text{ ms}$	$I_{FRM}$	1200	A
I <sup>2</sup> t-值 I <sup>2</sup> t - value	$V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 125^{\circ}\text{C}$ $V_R = 0\text{ V}, t_P = 10\text{ ms}, T_{vj} = 150^{\circ}\text{C}$	$I^2t$	40000 37500	A <sup>2</sup> s A <sup>2</sup> s

## 特征值 / Characteristic Values

		min.	typ.	max.	
正向电压 Forward voltage	$I_F = 600\text{ A}, V_{GE} = 0\text{ V}$		1,65	2,10	V
	$I_F = 600\text{ A}, V_{GE} = 0\text{ V}$		1,65		V
	$I_F = 600\text{ A}, V_{GE} = 0\text{ V}$		1,65		V
反向恢复峰值电流 Peak reverse recovery current	$I_F = 600\text{ A}, -di_F/dt = 5100\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		290		A
	$V_R = 600\text{ V}$		420		A
	$V_{GE} = -15\text{ V}$		450		A
恢复电荷 Recovered charge	$I_F = 600\text{ A}, -di_F/dt = 5100\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		62,0		$\mu\text{C}$
	$V_R = 600\text{ V}$		115		$\mu\text{C}$
	$V_{GE} = -15\text{ V}$		130		$\mu\text{C}$
反向恢复损耗 (每脉冲) Reverse recovery energy	$I_F = 600\text{ A}, -di_F/dt = 5100\text{ A}/\mu\text{s} (T_{vj}=150^{\circ}\text{C})$		22,0		mJ
	$V_R = 600\text{ V}$		44,0		mJ
	$V_{GE} = -15\text{ V}$		51,0		mJ
结 - 散热器热阻 Thermal resistance, junction to heatsink	每个二极管 / per diode valid with IFX pre-applied thermal interface material	$R_{thJH}$		0,105	K/W
在开关状态下温度 Temperature under switching conditions		$T_{vj\text{ op}}$	-40	150	$^{\circ}\text{C}$

## 负温度系数热敏电阻 / NTC-Thermistor

### 特征值 / Characteristic Values

		min.	typ.	max.	
额定电阻值 Rated resistance	$T_{NTC} = 25^{\circ}\text{C}$	$R_{25}$	5,00		k $\Omega$
R100 偏差 Deviation of R100	$T_{NTC} = 100^{\circ}\text{C}, R_{100} = 493\ \Omega$	$\Delta R/R$	-5	5	%
耗散功率 Power dissipation	$T_{NTC} = 25^{\circ}\text{C}$	$P_{25}$		20,0	mW
B-值 B-value	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/50}$	3375		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/80}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/80}$	3411		K
B-值 B-value	$R_2 = R_{25} \exp [B_{25/100}(1/T_2 - 1/(298,15\text{ K}))]$	$B_{25/100}$	3433		K

根据应用手册标定

Specification according to the valid application note.

## 模块 / Module

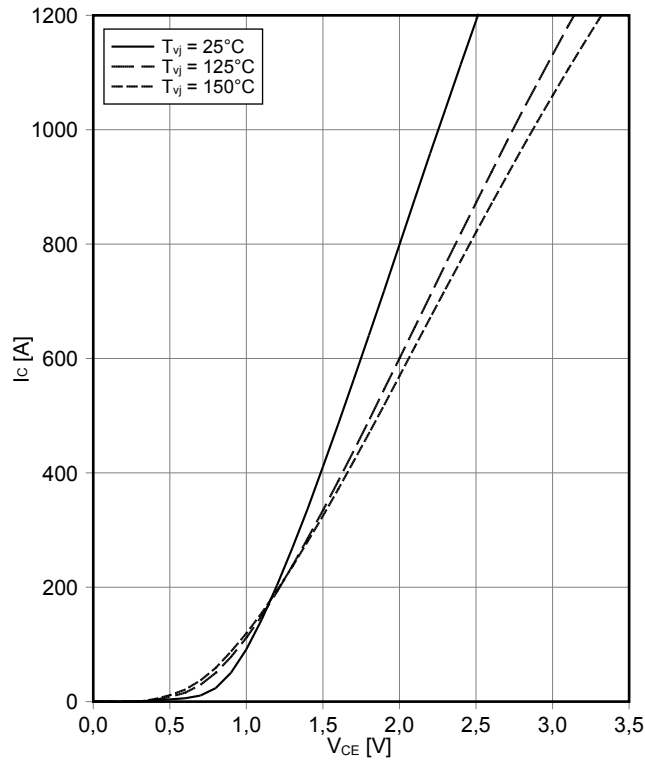
绝缘测试电压 Isolation test voltage	RMS, f = 50 Hz, t = 1 min	V <sub>ISOL</sub>	2,5		kV
模块基板材料 Material of module baseplate			Cu		
内部绝缘 Internal isolation	基本绝缘 (class 1, IEC 61140) basic insulation (class 1, IEC 61140)		Al <sub>2</sub> O <sub>3</sub>		
爬电距离 Creepage distance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		14,5 13,0		mm
电气间隙 Clearance	端子至散热器 / terminal to heatsink 端子至端子 / terminal to terminal		12,5 10,0		mm
相对电痕指数 Comperative tracking index		CTI	> 200		
			min.	typ.	max.
杂散电感, 模块 Stray inductance module		L <sub>sCE</sub>		20	nH
模块引线电阻, 端子-芯片 Module lead resistance, terminals - chip	T <sub>H</sub> = 25°C, 每个开关 / per switch	R <sub>CC+EE'</sub>		1,10	mΩ
储存温度 Storage temperature		T <sub>stg</sub>	-40		125 °C
最高基板工作温度 Maximum baseplate operation temperature		T <sub>BPmax</sub>			125 °C
模块安装的安装扭矩 Mounting torque for modul mounting	螺丝 M5 根据相应的应用手册进行安装 Screw M5 - Mounting according to valid application note	M	3,00		6,00 Nm
端子联接扭矩 Terminal connection torque	螺丝 M6 根据相应的应用手册进行安装 Screw M6 - Mounting according to valid application note	M	3,0	-	6,0 Nm
重量 Weight		G		345	g

Lagerung und Transport von Modulen mit TIM => siehe AN2012-07  
Storage and shipment of modules with TIM => see AN2012-07

输出特性 IGBT, 逆变器 (典型)

output characteristic IGBT, Inverter (typical)

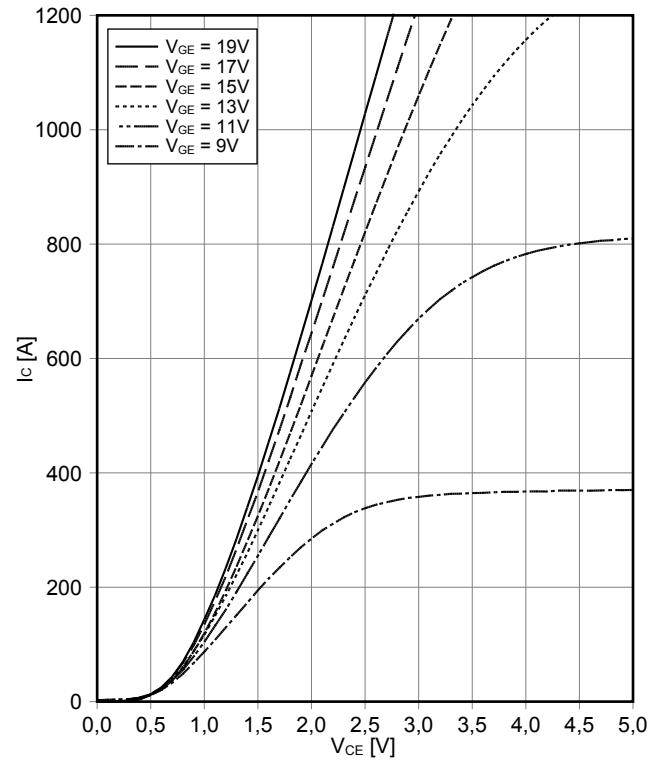
$I_C = f(V_{CE})$   
 $V_{GE} = 15\text{ V}$



输出特性 IGBT, 逆变器 (典型)

output characteristic IGBT, Inverter (typical)

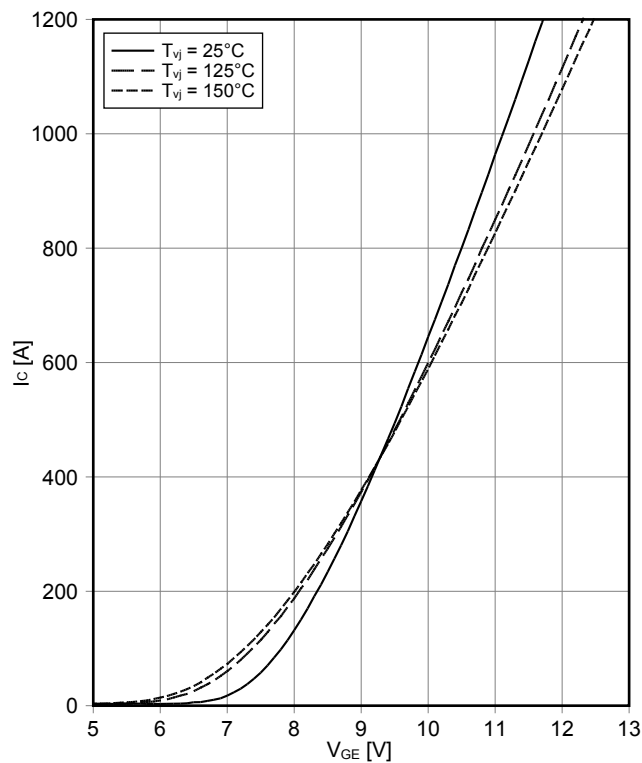
$I_C = f(V_{CE})$   
 $T_{vj} = 150^\circ\text{C}$



传输特性 IGBT, 逆变器 (典型)

transfer characteristic IGBT, Inverter (typical)

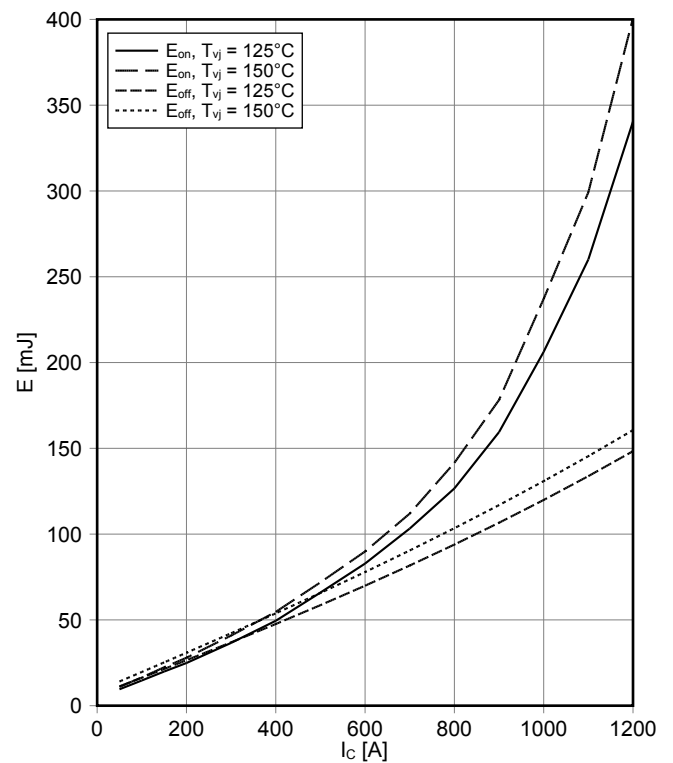
$I_C = f(V_{GE})$   
 $V_{CE} = 20\text{ V}$



开关损耗 IGBT, 逆变器 (典型)

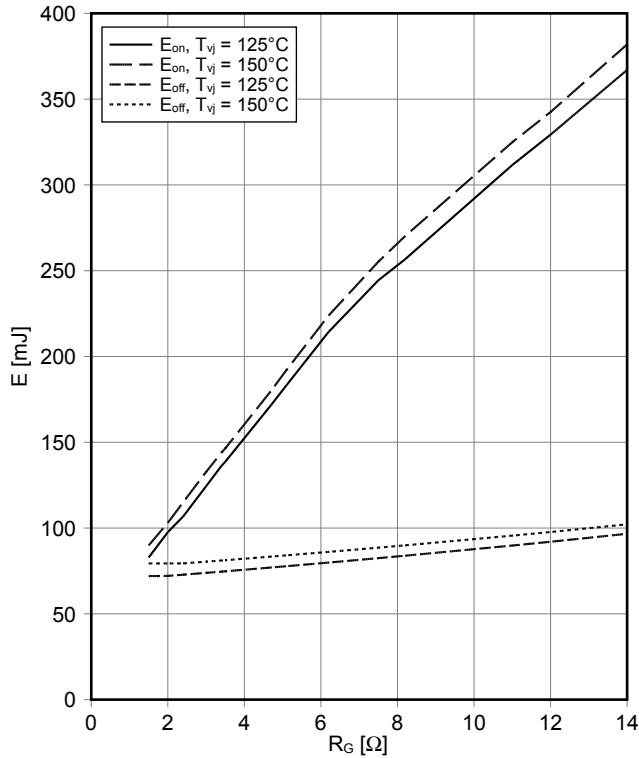
switching losses IGBT, Inverter (typical)

$E_{on} = f(I_C)$ ,  $E_{off} = f(I_C)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Gon} = 1.5\ \Omega$ ,  $R_{Goff} = 1.5\ \Omega$ ,  $V_{CE} = 600\text{ V}$

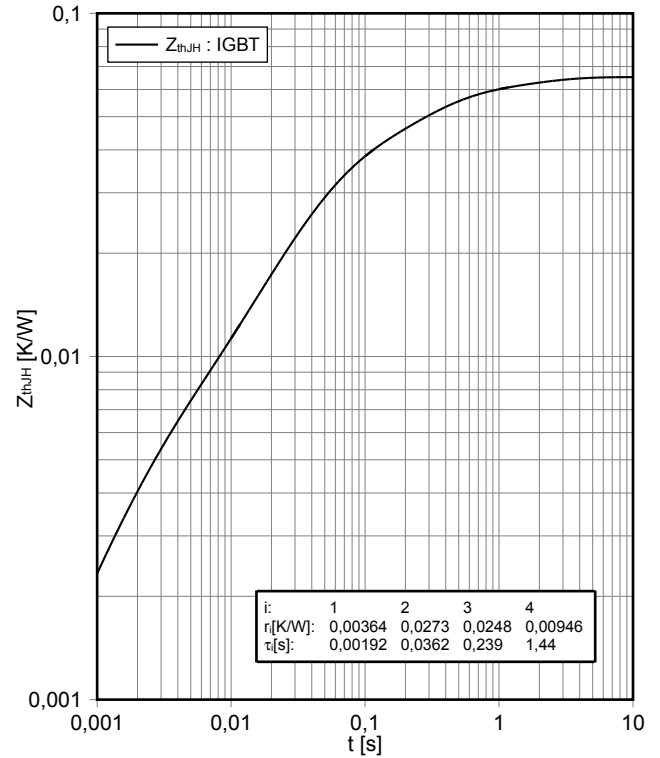


开关损耗 IGBT, 逆变器 (典型)  
**switching losses IGBT, Inverter (typical)**

$E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$   
 $V_{GE} = \pm 15\text{ V}$ ,  $I_C = 600\text{ A}$ ,  $V_{CE} = 600\text{ V}$

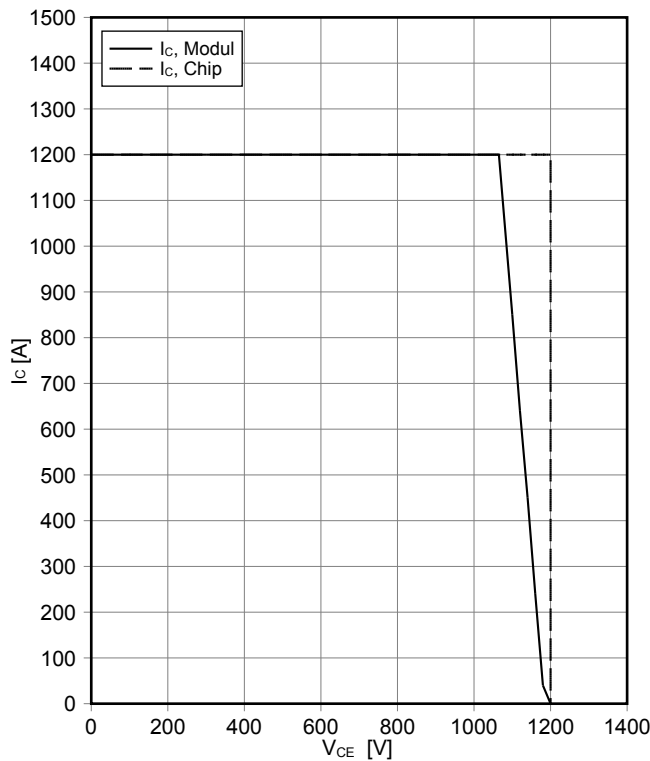


瞬态热阻抗 IGBT, 逆变器  
**transient thermal impedance IGBT, Inverter**  
 $Z_{thJH} = f(t)$

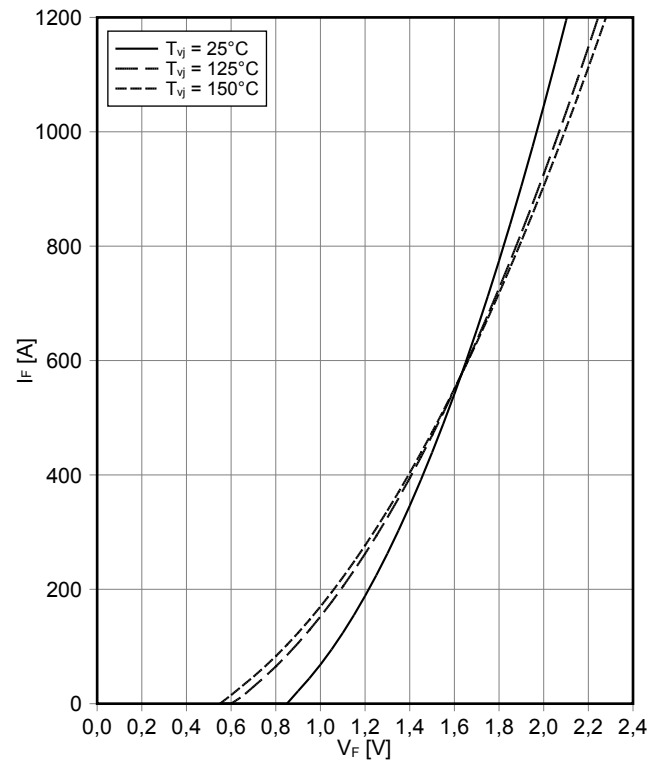


反偏安全工作区 IGBT, 逆变器 (RBSOA)  
**reverse bias safe operating area IGBT, Inverter (RBSOA)**

$I_C = f(V_{CE})$   
 $V_{GE} = \pm 15\text{ V}$ ,  $R_{Goff} = 1.5\ \Omega$ ,  $T_{vj} = 150^\circ\text{C}$

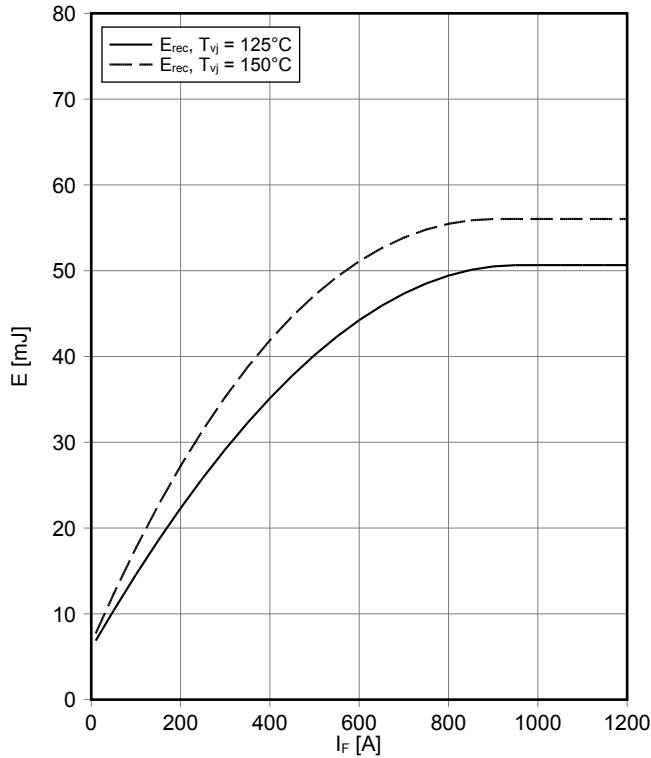


正向偏压特性 二极管, 逆变器 (典型)  
**forward characteristic of Diode, Inverter (typical)**  
 $I_F = f(V_F)$



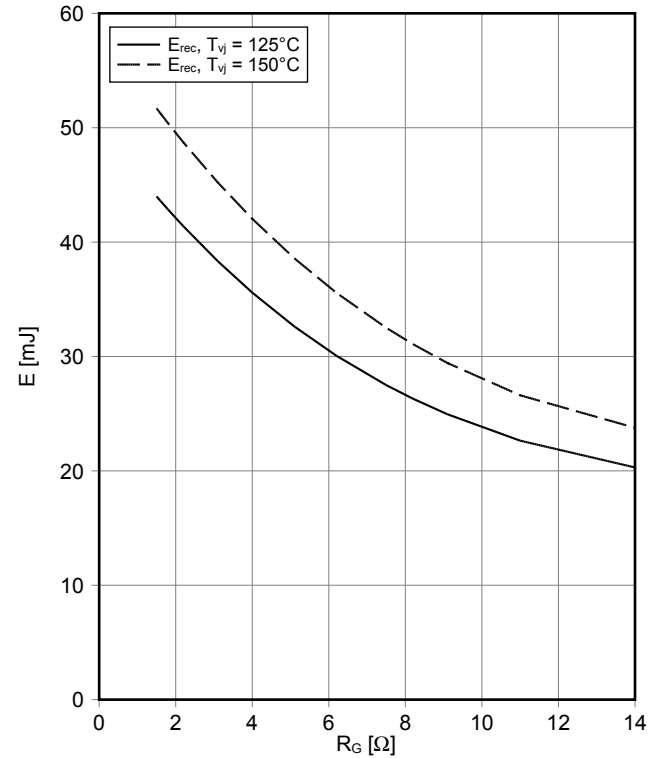
开关损耗 二极管,逆变器 (典型)  
switching losses Diode, Inverter (typical)

$E_{rec} = f(I_F)$   
 $R_{Gon} = 1.5 \Omega, V_{CE} = 600 V$



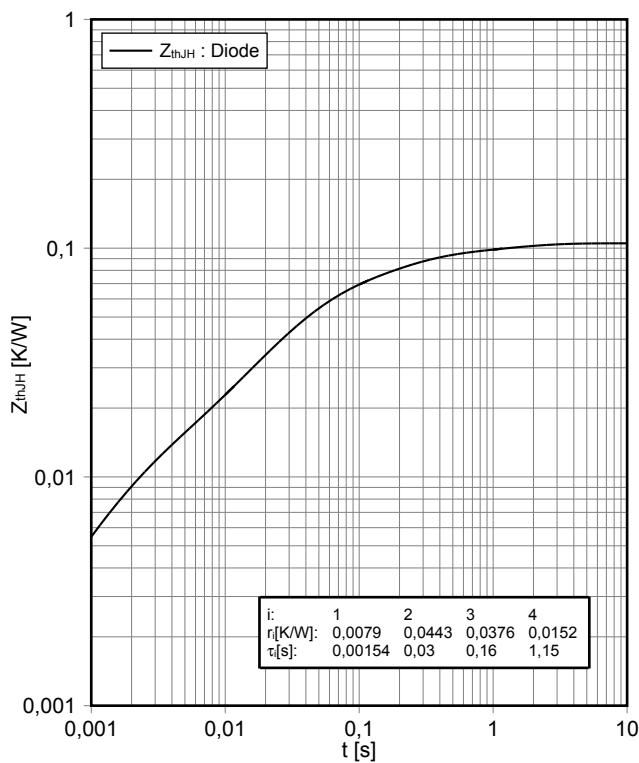
开关损耗 二极管,逆变器 (典型)  
switching losses Diode, Inverter (typical)

$E_{rec} = f(R_G)$   
 $I_F = 600 A, V_{CE} = 600 V$



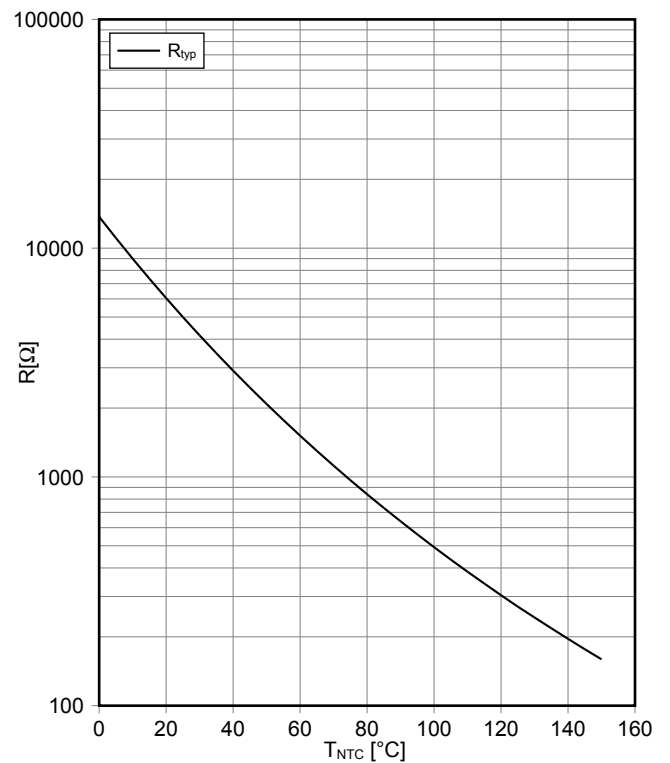
瞬态热阻抗 二极管,逆变器  
transient thermal impedance Diode, Inverter

$Z_{thJH} = f(t)$

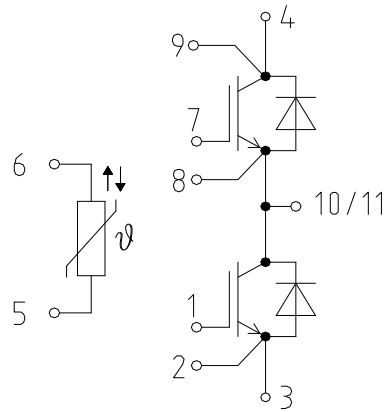


负温度系数热敏电阻 温度特性  
NTC-Thermistor-temperature characteristic (typical)

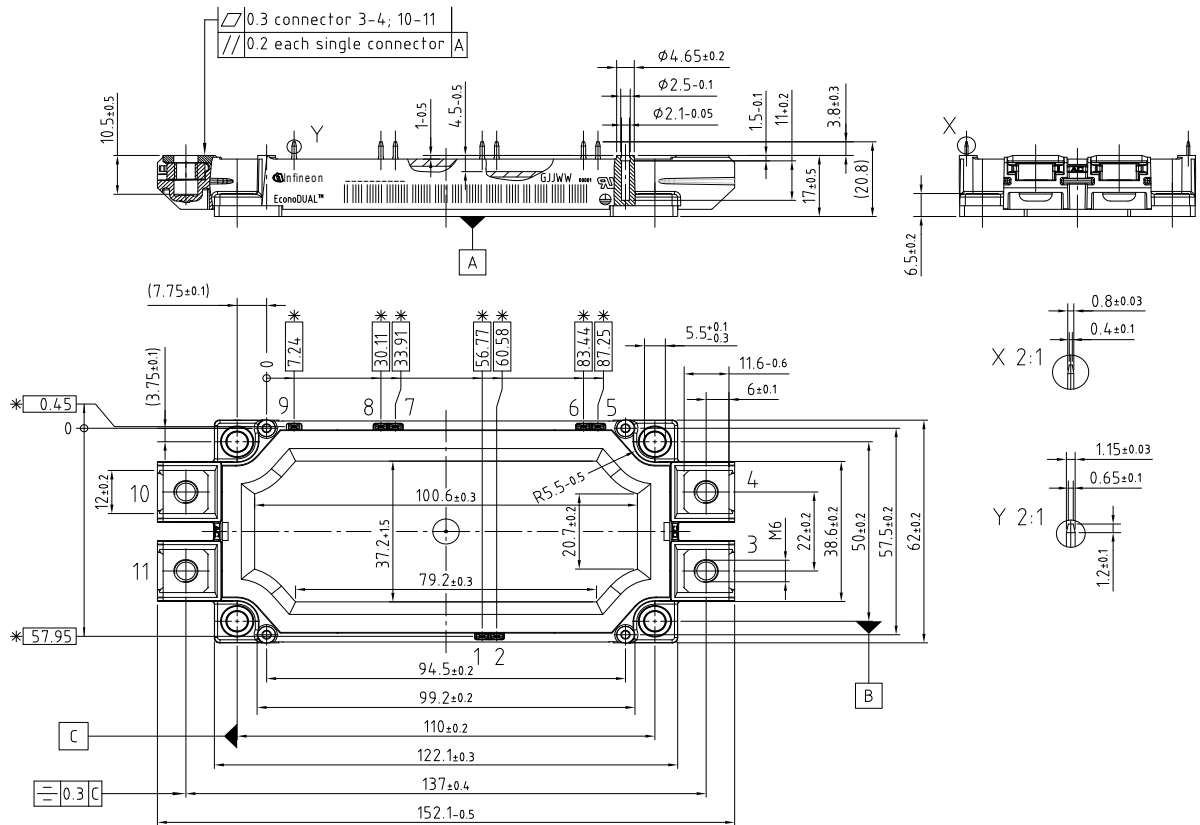
$R = f(T)$



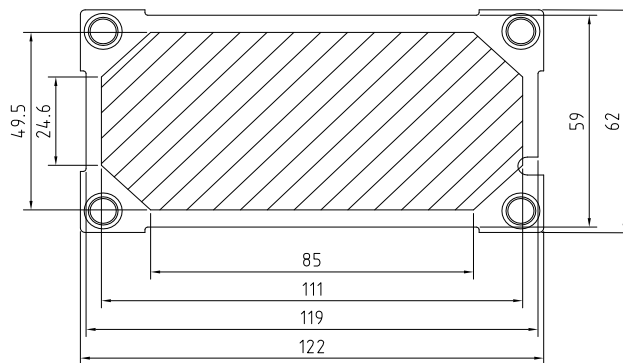
## 接线图 / Circuit diagram



## 封装尺寸 / Package outlines



\* = all dimensions with a tolerance of  $\pm 0.5$   
 dimensions valid in mounted condition



restricted area for Thermal Interface Material



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